



SSL32 THRU SSL34

3.0 AMPS. Surface Mount Low V_F Schottky Barrier Rectifiers



Voltage Range
20 to 40 Volts
Current
3.0 Amperes

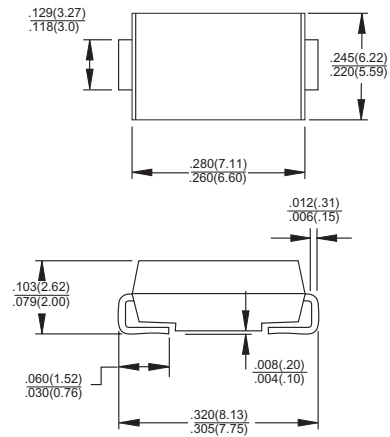
Features

- ✧ For surface mounted application
- ✧ Metal silicon junction, majority carrier conduction
- ✧ Low forward voltage drop
- ✧ Easy pick and place
- ✧ High surge current capability
- ✧ Plastic material used carries Underwriters Laboratory Classification 94V-O
- ✧ Epitaxial construction
- ✧ High temperature soldering:
260°C / 10 seconds at terminals

Mechanical Data

- ✧ Cases: Molded plastic
- ✧ Terminals: Solder plated
- ✧ Polarity: Indicated by cathode band
- ✧ Packaging: 16mm tape per EIA STD RS-481
- ✧ Weight: 0.21gram

SMC/DO-214AB



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	SSL32	SSL33	SSL34	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	20	30	40	V
Maximum RMS Voltage	V_{RMS}	14	21	28	V
Maximum DC Blocking Voltage	V_{DC}	20	30	40	V
Maximum Average Forward Rectified Current See Fig. 1	$I_{(AV)}$	3.0			A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	100			A
Maximum Instantaneous Forward Voltage (Note 1) @3.0A	V_F	0.385		0.40	V
Maximum DC Reverse Current @ $T_A=25^{\circ}C$ at Rated DC Blocking Voltage @ $T_A=100^{\circ}C$	I_R	1.0			mA
		150			mA
Maximum Thermal Resistance (Note 2)	$R\theta_{JL}$	17			$^{\circ}C/W$
	$R\theta_{JA}$	55			
Marking Code		SL32	SL33	SL34	
Operating Temperature Range	T_J	-55 to +125			$^{\circ}C$
Storage Temperature Range	T_{STG}	-55 to + 150			$^{\circ}C$

Notes:1. Pulse Test with PW=300 usec, 1% Duty Cycle.

2. Measured on P.C. Board with 0.6 x 0.6"(16 x 16mm) Copper Pad Areas.

RATINGS AND CHARACTERISTIC CURVES (SSL32 THRU SSL34)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

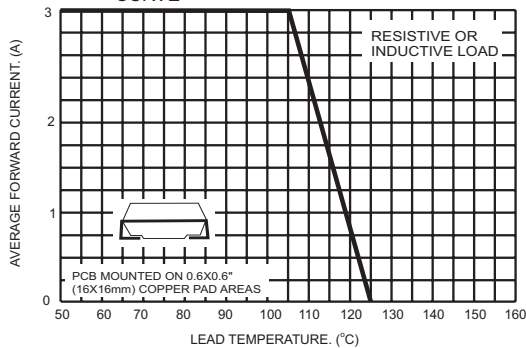


FIG.2- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

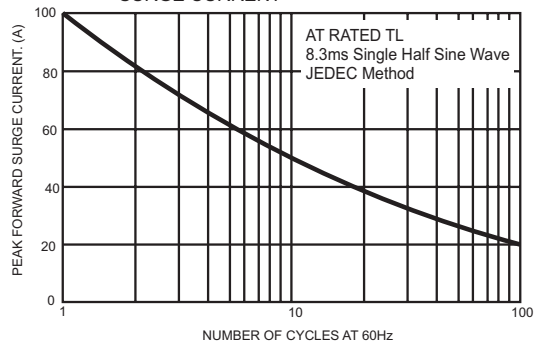


FIG.3- TYPICAL FORWARD CHARACTERISTICS

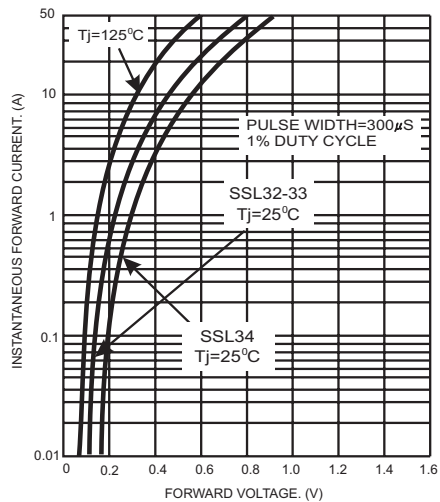


FIG.4- TYPICAL REVERSE CHARACTERISTICS

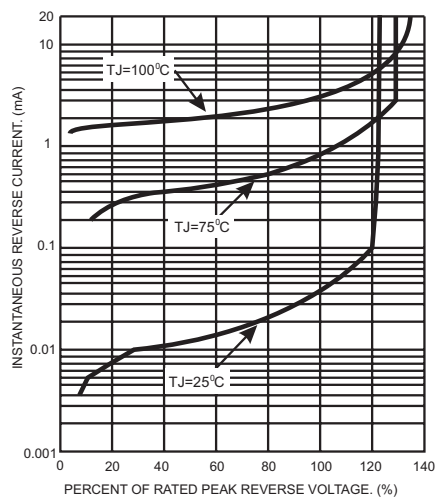


FIG.5- TYPICAL JUNCTION CAPACITANCE

